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FDB8876 N-Channel PowerTrench[®] MOSFET

FAIRCHILD

SEMICONDUCTOR®

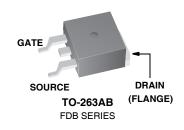
FDB8876 N-Channel PowerTrench[®] MOSFET 30V, 71A, 8.5mΩ

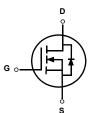
General Descriptions

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(ON)}$ and fast switching speed.

Features

- $r_{DS(ON)}$ = 8.5mΩ, V_{GS} = 10V, I_D = 40A
- $r_{DS(ON)}$ = 10.3mΩ, V_{GS} = 4.5V, I_D = 40A
- High performance trench technology for extremely low rDS(ON)
- Low gate charge
- High power and current handling capability
- RoHS Compliant





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain to Source Voltage	30	V
V _{GS}	Gate to Source Voltage	±20	V
	Drain Current		
Continuous (Continuous (T _C = 25 ^o C, V _{GS} = 10V)	71	A
D	Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 4.5V$)	65	A
	Pulsed	Figure 4	Α
E _{AS}	Single Pulse Avalanche Energy (Note 1)	180	mJ
P _D	Power dissipation	70	W
T _J , T _{STG}	Operating and Storage Temperature	-55 to 175	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance Junction to Case TO-263	2.14	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance Junction to Ambient TO-263,1in ² copper pad area	43	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8876	FDB8876	TO-263AB	330mm	24mm	800 units

Symbol	Parameter	Test Conditions		Min	Тур	Мах	Units
Off Chara	acteristics						
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		30	-	-	V
	Zara Cata Valtaga Drain Current	V _{DS} = 24V				1	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0V	T _A = 150 ^o C	-	-	250	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Chara	acteristics						
V _{GS(TH)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2$	250μΑ	1.2	-	2.5	V
00(11)			I _D = 40A, V _{GS} = 10V		5.7	8.5	
r	Drain to Source On Resistance	I _D = 40A, V _{GS} = 4		-	7.3	10.3	mΩ
r _{DS(ON)}	Drain to Source On Resistance	$I_D = 40, V_{GS} = 10V,$ $T_A = 175^{\circ}C$		-	11	14	1115.2
Dynamic _{CISS}	Characteristics				1700		pF
	Output Capacitance	– V _{DS} = 15V, V _{GS} =	= 0V,	-	340	-	pF
C _{OSS} C _{RSS}	Reverse Transfer Capacitance	f = 1MHz	-	-	220	-	pr
URSS	Gate Resistance	V _{GS} =0.5V, f = 1N	ЛНz		2.1		•
	Gate Resistance						Ω
R _G			$V_{DD} = 15V$	-	32	45	Ω nC
R _G Q _{g(TOT)}	Total Gate Charge at 10V	V _{GS} = 0V to 10V	V _{DD} = 15V I _D = 40A	-	32 17	45 24	
R _G Q _{g(TOT)} Q _{g(5)}	Total Gate Charge at 10V Total Gate Charge at 5V	$V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$	I _D = 40A		-	-	nC
$\begin{array}{c} R_{G} \\ Q_{g(TOT)} \\ Q_{g(5)} \\ Q_{g(TH)} \end{array}$	Total Gate Charge at 10V	V _{GS} = 0V to 10V	I _D = 40A	-	17	24	nC nC
$\begin{array}{c} R_{G} \\ Q_{g(TOT)} \\ Q_{g(5)} \\ Q_{g(TH)} \\ Q_{gs} \end{array}$	Total Gate Charge at 10V Total Gate Charge at 5V Threshold Gate Charge	$V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$	I _D = 40A	-	17 1.6	24	nC nC nC
$\begin{array}{c} {\sf R}_{\sf G} & \\ {\sf Q}_{{\sf g}({\sf TOT})} & \\ {\sf Q}_{{\sf g}(5)} & \\ {\sf Q}_{{\sf g}({\sf TH})} & \\ {\sf Q}_{{\sf gs}} & \\ {\sf Q}_{{\sf gs}2} & \end{array}$	Total Gate Charge at 10V Total Gate Charge at 5V Threshold Gate Charge Gate to Sourse Gate Charge	$V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$	I _D = 40A		17 1.6 4.7	24 2.4 -	nC nC nC nC
R _G Q _{g(TOT)} Q _{g(5)} Q _{g(TH)} Q _{gs} Q _{gs2} Q _{gd}	Total Gate Charge at 10VTotal Gate Charge at 5VThreshold Gate ChargeGate to Sourse Gate ChargeGate Charge Threshold to PlateauGate to Drain "Miller" Charge	$V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$	I _D = 40A		17 1.6 4.7 3.1	24 2.4 - -	nC nC nC nC nC
$\begin{array}{c} {\sf R}_{\sf G} & \\ {\sf Q}_{{\sf g}({\sf TOT})} & \\ {\sf Q}_{{\sf g}({\sf 5})} & \\ {\sf Q}_{{\sf g}({\sf TH})} & \\ {\sf Q}_{{\sf g}{\sf s}} & \\ {\sf Q}_{{\sf g}{\sf s}2} & \\ {\sf Q}_{{\sf g}{\sf d}} & \\ \\ \\ {\sf Switchin} \end{array}$	Total Gate Charge at 10V Total Gate Charge at 5V Threshold Gate Charge Gate to Sourse Gate Charge Gate Charge Threshold to Plateau	$V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$	I _D = 40A		17 1.6 4.7 3.1	24 2.4 - -	nC nC nC nC nC
R _G Q _{g(TOT)} Q _{g(5)} Q _{g(TH)} Q _{gs} Q _{gs2} Q _{gd}	Total Gate Charge at 10V Total Gate Charge at 5V Threshold Gate Charge Gate to Sourse Gate Charge Gate Charge Threshold to Plateau Gate to Drain "Miller" Charge g Characteristics (V _{GS} = 10V)	$V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$	I _D = 40A		17 1.6 4.7 3.1 6.8	24 2.4 - -	nC nC nC nC nC

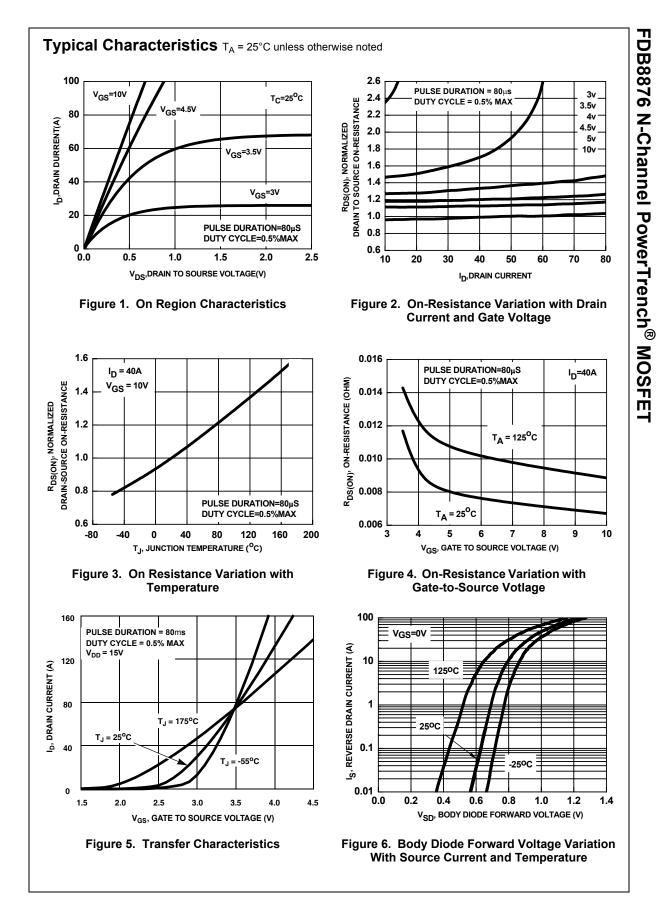
ON			-	-	105	115
t _{d(ON)}	Turn-On Delay Time		-	9	-	ns
t _r	Rise Time	V _{DD} = 15V, I _D = 40A	-	113	-	ns
t _{d(OFF)}	Turn-Off Delay Time	V _{GS} = 10V, R _{GS} = 10Ω	-	50	-	ns
t _f	Fall Time		-	41	-	ns
t _{OFF}	Turn-Off Time		-	-	137	ns

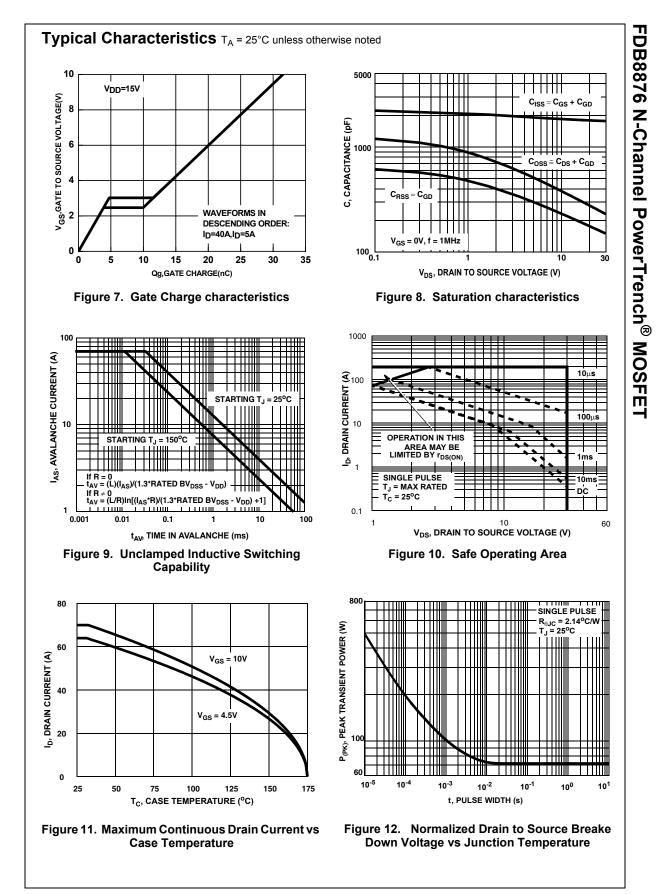
Drain-Source Diode Characteristic

V	SD Source to Drain Diode Voltage	I _{SD} = 40A	-	-	1.25	V
V _{SD}		I _{SD} = 3.2A	-	-	1.0	V
t _{rr}	Reverse Recovery Time	I_{SD} = 40A, dI _{SD} /dt=100A/µs	-	-	22	ns
Q _{RR}	Reverse Recovered Charge	I_{SD} = 40A, d I_{SD} /dt=100A/µs	-	-	8	nC

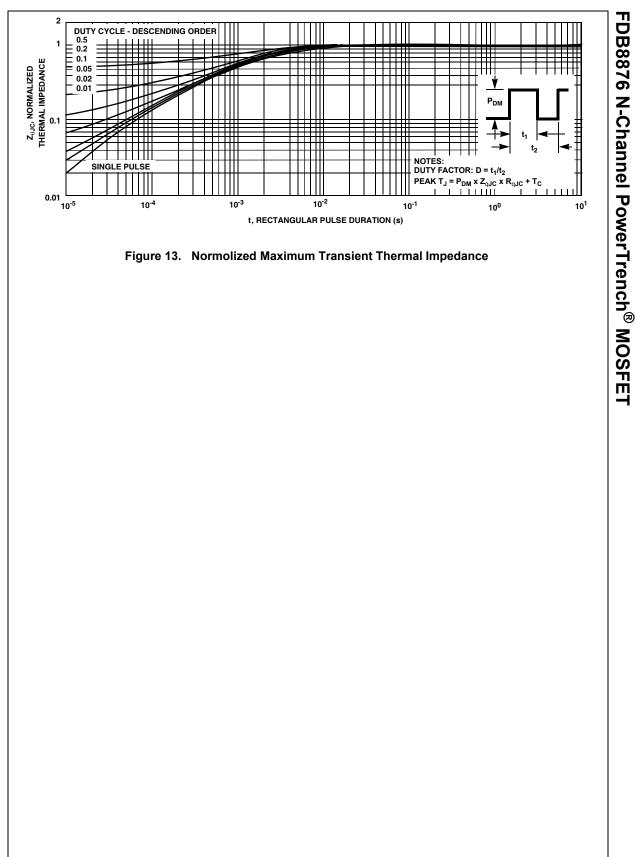
Notes:

1: Starting T_J =25^OC,L=1mH,I_{AS}=19A,V_{DD}=27V,V_{GS}=10V





Typical Characteristics T_A = 25°C unless otherwise noted



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